SPECIFICATION
FOR
APPROVAL

(●) **Preliminary Specification**
( ) **Final Specification**

Title	32.0” WXGA TFT LCD

BUYER	konka
MODEL	

SUPPLIER	LG.Display Co., Ltd.
*MODEL	LC320DXY
SUFFIX	SHA5 (RoHS Verified)

APPROVED BY		SIGNATURE DATE
/		
/		
/		

Please return 1 copy for your confirmation with your signature and comments.

APPROVED BY		SIGNATURE DATE
/ Team Leader		
REVIEWED BY / Project Leader		
PREPARED BY / Engineer		

TV Products Development Dept.
LG. Display LCD Co., Ltd

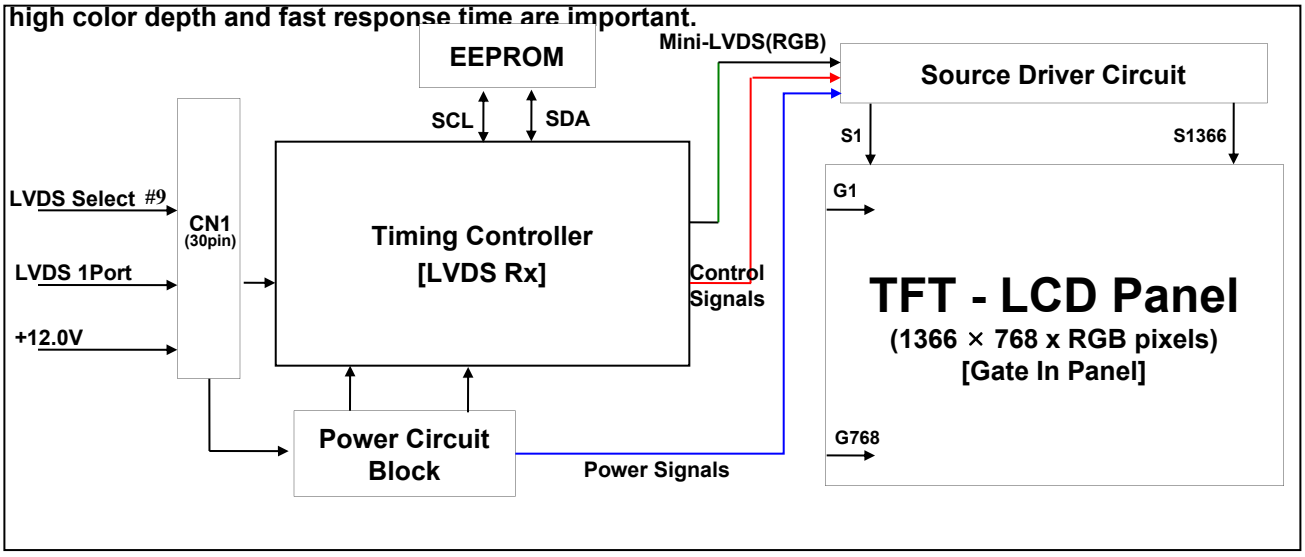
CONTENTS

RECORD OF REVISIONS

Revision No.	Revision Date	Page	Description
0.1	Feb, 26, 2015	-	Preliminary Specification(First Draft)
0.2	May, 24, 2015	14	OPTICAL CHARACTERISTICS is Changed

1. General Description

The LC320DXY is a Color Active Matrix Liquid Crystal Display with an integral the Source PCB and Gate implanted on Panel (GIP). The matrix employs a-Si Thin Film Transistor as the active element. It is a transmissive type display operating in the normally black mode. It has a 31.51 inch diagonally measured active display area with WXGA resolution (768 vertical by 1366 horizontal pixel array). Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the luminance of the sub-pixel color is determined with a 8-bit gray scale signal for each dot.
Therefore, it can present a palette of more than 16.7M(6bit + FRC) colors.
It is intended to support LCD TV, PCTV where high brightness, super wide viewing angle, high color gamut, high color depth and fast response time are important.



General Features

Active Screen Size	31.51 inches(800.4mm) diagonal
Outline Dimension	715.0(H) x 411.0 (V) x 1.4 mm(D) (Typ.)
Pixel Pitch	170.25㎛ x 510.75㎛ x RGB
Pixel Format	1366 horiz. by 768 vert. Pixels, RGB stripe arrangement
Color Depth	8-bit (D), 16.7 M colors
Drive IC Data Interface	Source D-IC : 6-bit mini-LVDS, gamma reference voltage, and control signals Gate D-IC : Gate In Panel
Viewing Angle (CR>10)	Viewing angle free (R/L 178 (Min.), U/D 178 (Min.))
Weight	0.86 Kg (Typ.)
Display Mode	Transmissive mode, Normally black
Surface Treatment (Top)	Hard coating(3H), Anti-glare treatment of the front polarizer (Haze 1%(Typ.))

2. Absolute Maximum Ratings

The following items are maximum values which, if exceeded, may cause faulty operation or permanent dama to the LCD module.

Table 1. ABSOLUTE MAXIMUM RATINGS

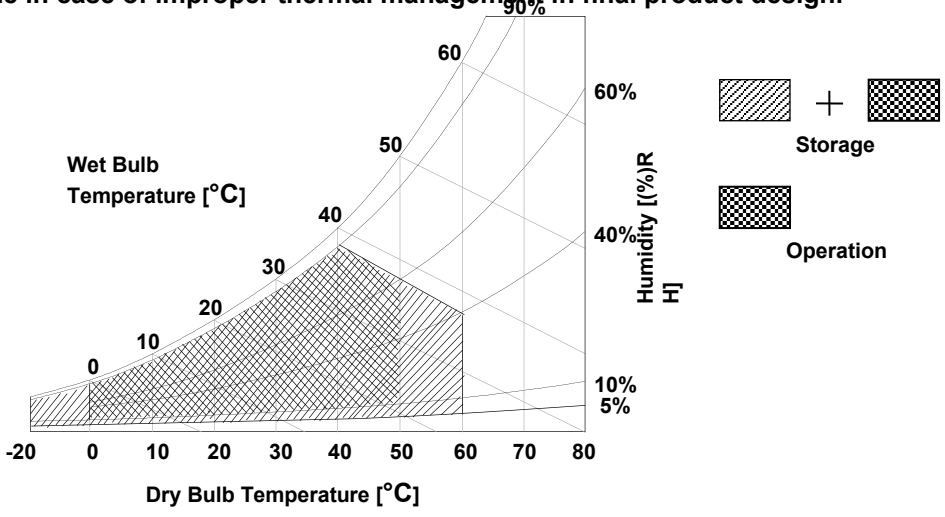
Parameter		Symbol	Value		Unit	Note
			Min	Max		
Power Input Voltage	LCD Circuit	VLCD	-0.3	+14.0	VDC	1
T-Con Option Selection Voltage		VLOGIC	-0.3	+4.0	VDC	
Operating Temperature		TOP	0	+50	°C	2,3
Storage Temperature(without packing)		TST	-20	+60	°C	
Panel Front Temperature		TSUR	-	+68	°C	4
Operating Ambient Humidity		HOP	10	90	%RH	2,3
Storage Humidity		HST	5	90	%RH	

Notes: 1. Ambient temperature condition (Ta = 25 ± 2 °C)

2. Temperature and relative humidity range are shown in the figure below. Wet bulb temperature should be Max 39 °C and no condensation of water.

3. Gravity mura can be guaranteed below 40℃ condition.

4. The maximum operating temperature is based on the test condition that the surface temperatur e of display area is less than or equal to 68 ℃ with LCD module alone in a temperature controlled chamber. Thermal management should be considered in final product design to prevent the sur face temperature of display area from being over 68 ℃. The range of operating temperature may degrade in case of improper thermal management in final product design.



3. Electrical Specifications

3-1. Electrical Characteristics

Table 2. ELECTRICAL CHARACTERISTICS

Parameter		Symbol	Value			Unit	Note
			Min	Typ	Max		
Circuit :							
Power Input Voltage		V_{LCD}	10.8	12.0	13.2	V_{DC}	
Power Input Current		I_{LCD}	-	235	306	mA	1
			-	286	372	mA	2
T-CON Option Selection Voltage	Input High Voltage	V_{IH}	2.7	-	3.6	V_{DC}	
	Input Low Voltage	V_{IL}	0	-	0.7	V_{DC}	
Power Consumption		P_{LCD}	-	2.82	3.67	Watt	1
Rush current		I_{RUSH}	-	-	4.0	A	3

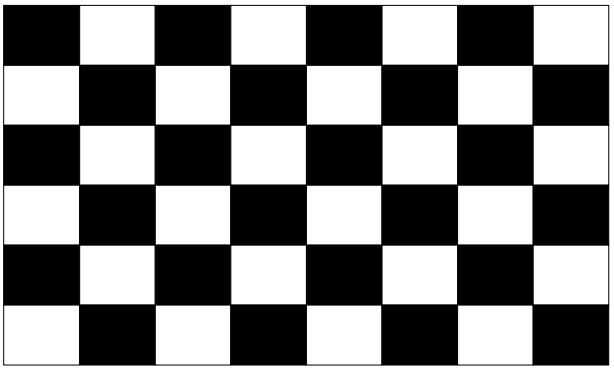
Notes : 1. The specified current and power consumption are under the V_{LCD}=12.0V, Ta=25 ± 2°C, f_V=60 Hz condition, and mosaic pattern(8 x 6) is displayed and f_V is the frame frequency.

2. The current is specified at the maximum current pattern.

3. The duration of rush current is about 2ms and rising time of power input is 0.5ms (min.).

4. Ripple voltage level is recommended under ±5% of typical voltage

White : 255 Gray
Black : 0 Gray



Mosaic Pattern(8 x 6)

3-2. Interface Connections

3-2-1. LCD Module

- LCD Connector(CN1) : FI-X30SSL-HF (Manufactured by JAE) or Compatible.
- Mating Connector : FI-X30C2L (Manufactured by JAE) or Equivalent

Table 3. MODULE CONNECTOR(CN1) PIN CONFIGURATION

Pin No.	Symbol	Description	Note
1	VLCD	Power Supply +12.0V	
2	VLCD	Power Supply +12.0V	
3	VLCD	Power Supply +12.0V	
4	VLCD	Power Supply +12.0V	
5	GND	Ground	
6	GND	Ground	
7	GND	Ground	
8	GND	Ground	
9	LVDS Select	'H' =JEIDA , 'L' or NC = VESA	Appendix III
10	NC	No Connection	4
11	GND	Ground	
12	RA-	LVDS Receiver Signal(-)	
13	RA+	LVDS Receiver Signal(+)	
14	GND	Ground	
15	RB-	LVDS Receiver Signal(-)	
16	RB+	LVDS Receiver Signal(+)	
17	GND	Ground	
18	RC-	LVDS Receiver Signal(-)	
19	RC+	LVDS Receiver Signal(+)	
20	GND	Ground	
21	RCLK-	LVDS Receiver Clock Signal(-)	
22	RCLK+	LVDS Receiver Clock Signal(+)	
23	GND	Ground	
24	RD-	LVDS Receiver Signal(-)	
25	RD+	LVDS Receiver Signal(+)	
26	GND	Ground	
27	NC	No Connection (Note 4)	4
28	NC	No Connection (Note 4)	4
29	NC	No Connection (Note 4)	4
30	GND	Ground	

Notes :

1. **All GND (Ground) pins should be connected together to the LCD module's metal frame.**
2. **All VLCD (power input) pins should be connected together.**
3. **All Input levels of LVDS signals are based on the EIA 644 Standard.**
4. **These pins are used only for LGD (Do not connect)**
5. **Specific pin No. #30 is used for "No signal detection" of system signal interface.**
   It should be GND for NSB (No Signal Black) while the system interface signal is not.
   If this pin is "H", LCD Module displays AGP (Auto Generation Pattern).

3-3. Signal Timing Specifications

Table 4 shows the signal timing required at the input of the LVDS transmitter. All of the interface sign al timings should be satisfied with the following specification for normal operation.

Table 4. TIMING TABLE for NTSC & PAL(DE Only Mode)

ITEM		Symbol	Min	Typ	Max	Unit	Note
Horizontal	Display P eriod	t_{HV}	1366	1366	1366	tclk	
	Blank	t_{HB}	90	162	410	tclk	
	Total	t_{HP}	1456	1528	1776	tclk	
Vertical	Display P eriod	t_{VV}	768	768	768	t_{HP}	
	Blank	t_{VB}	20	22	295	t_{HP}	1
	Total	t_{VP}	788	790	1063	t_{HP}	

ITEM		Symbol	Min	Typ	Max	Unit	Note
Frequency	DCLK	f_{CLK}	63.0	72.4	80.0	MHz	
	Horizonta l	f_H	45	47.4	55	KHz	2
	Vertical	f_V	47	60	63	Hz	2

Note: 1. The input of HSYNC & VSYNC signal does not have an effect on normal operation (DE Only Mod e).

If you use spread spectrum of EMI, add some additional clock to minimum value for clock margi n.

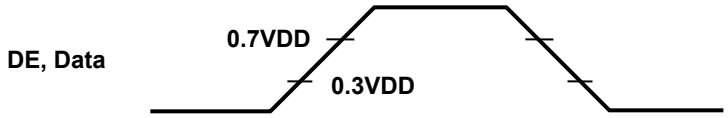
2. The performance of the electro-optical characteristics may be influenced by variance of the verti cal

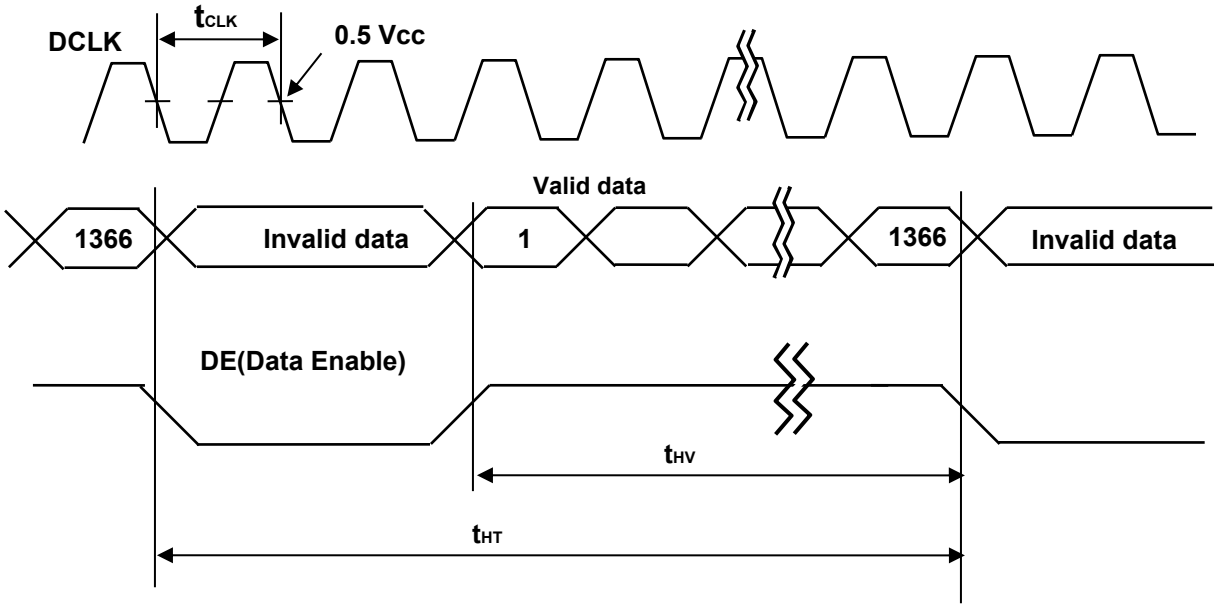
refresh rate and the horizontal frequency

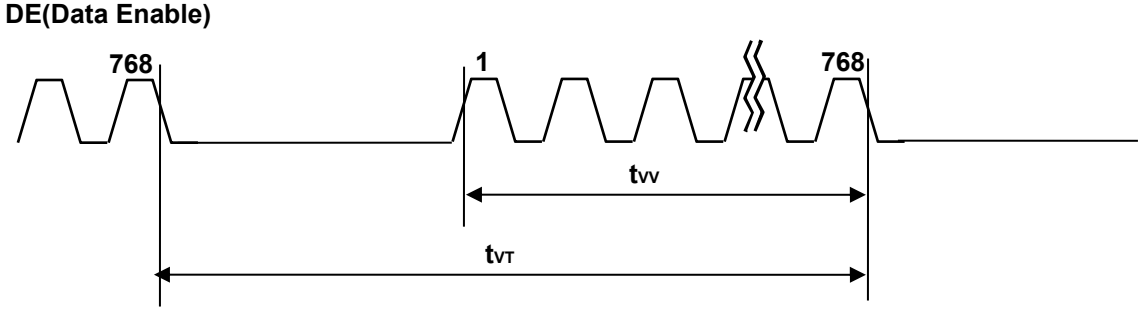
※ Timing should be set based on clock frequency.

3-4. LVDS Signal Specification

3-4-1. LVDS Input Signal Timing Diagram

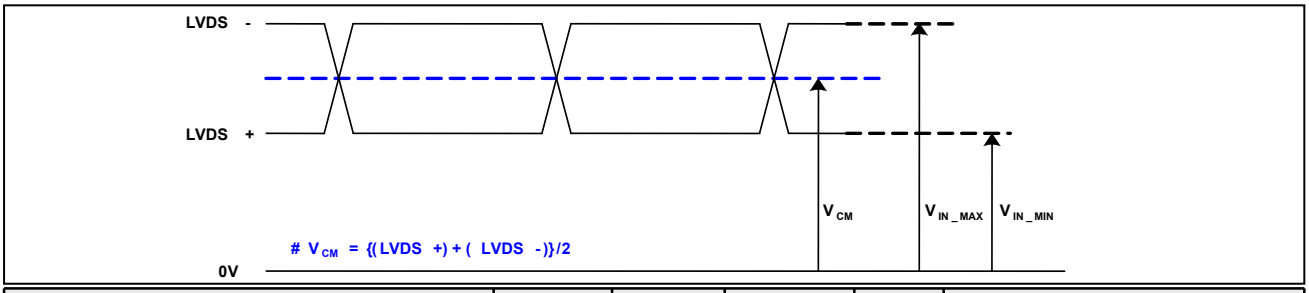






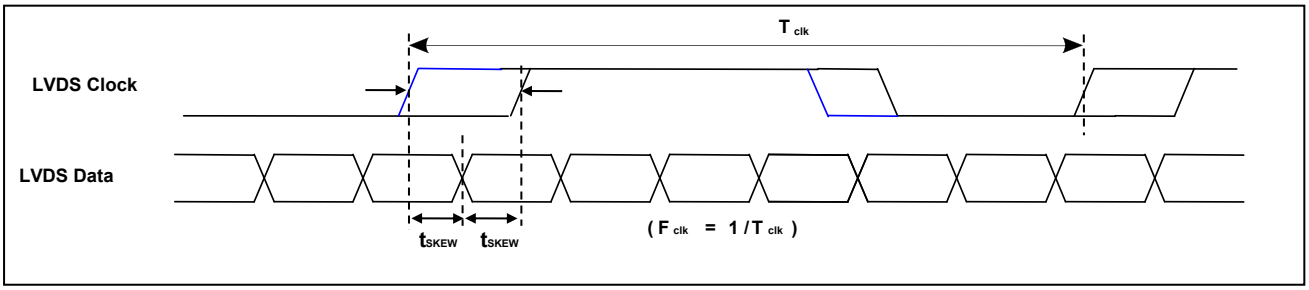
3-4-2. LVDS Input Signal Characteristics

1) DC Specification



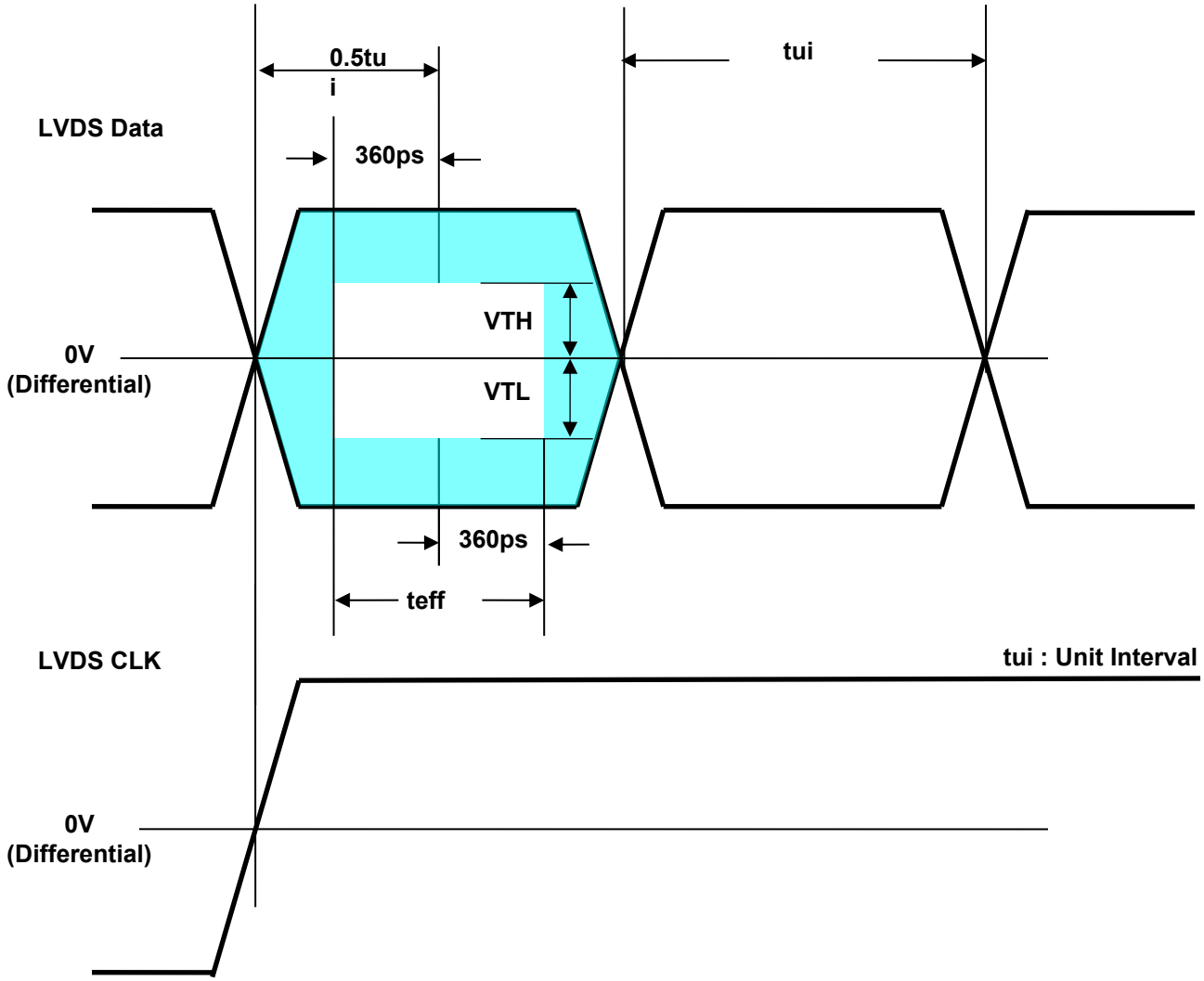
Description	Symbol	Min	Max	Unit	Note
LVDS Common mode Voltage	V_{CM}	1.0	1.5	V	-
LVDS Input Voltage Range	V_{IN}	0.7	1.8	V	-
Change in common mode Voltage	ΔVCM	-	250	mV	-

2) AC Specification



Description	Symbol	Min	Max	Unit	Note
LVDS Differential Voltage	V_{TH}	100	600	mV	Tested with Differential Probe 2
	V_{TL}	-600	-100	mV	
LVDS Clock to Data Skew	t_{SKEW}	-	$\lvert(0.20*T_{clk})/7\rvert$	ps	-
Effective time of LVDS	t_{eff}	$\lvert\pm360\rvert$	-	ps	-

notes 1. All Input levels of LVDS signals are based on the EIA 644 Standard.
2. LVDS Differential Voltage is defined within t_{eff}



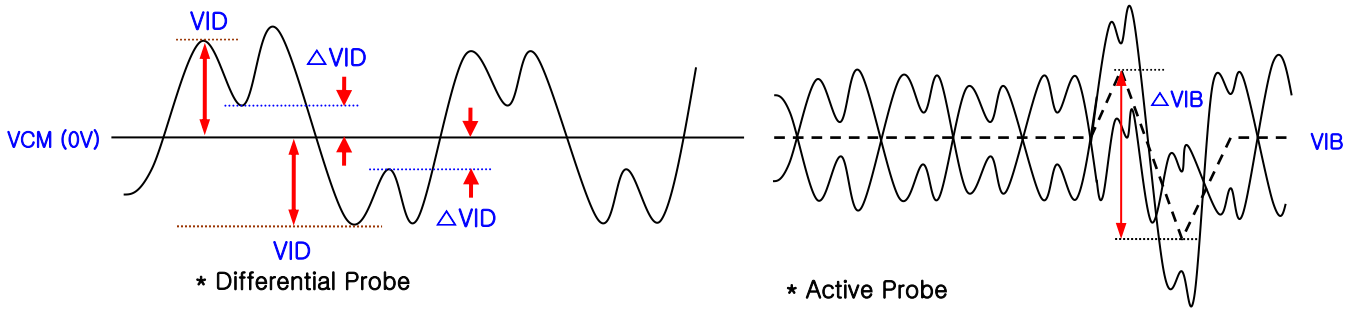
*** This accumulated waveform is tested with differential probe**

3-5. Intra interface Signal Specification

3-5-1. Mini-LVDS Signal Specification

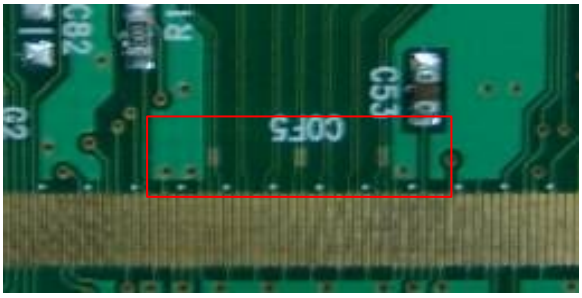
Table 5. ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit	notes
Mini-LVDS Clock frequency	CLK	3.0V≤VCC ≤3.6V		-	290	MHz	
mini-LVDS input Voltage (Center)	V_{IB}	Mini-LVDS Clock and Data	0.7 + (VID/2)	-	(VCC-1.2) − VID / 2	V	
mini-LVDS input Voltage Distortion (Center)	ΔV_{IB}		-	-	0.8	V	
mini-LVDS differential Voltage range	V_{ID}		200	-	800	mV	
mini-LVDS differential Voltage range Dip	ΔV_{ID}		25	-	800	mV	



Description of VID, ΔVIB, ΔVID

* Source PCB



Measure point

3-6. Color Data Reference

The brightness of each primary color(red,green,blue) is based on the 8bit gray scale data input for the c olor.
The higher binary input, the brighter the color. Table 6 provides a reference for color versus data input.

Table 6. COLOR DATA REFERENCE

Color		Input Color Data																							
		RED								GREEN								BLUE							
		MSB							LSB	MSB							LSB	MSB							LSB
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
Basic Color	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green (255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue (255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RED	RED (000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (001)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	...	...								...								...							
	RED (254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
GREEN	GREEN (000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN (001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	...	...								...								...							
	GREEN (254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	GREEN (255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
BLUE	BLUE (000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE (001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	...	...								...								...							
	BLUE (254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	BLUE (255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

3-6. Power Sequence

3-6-1. LCD Driving circuit

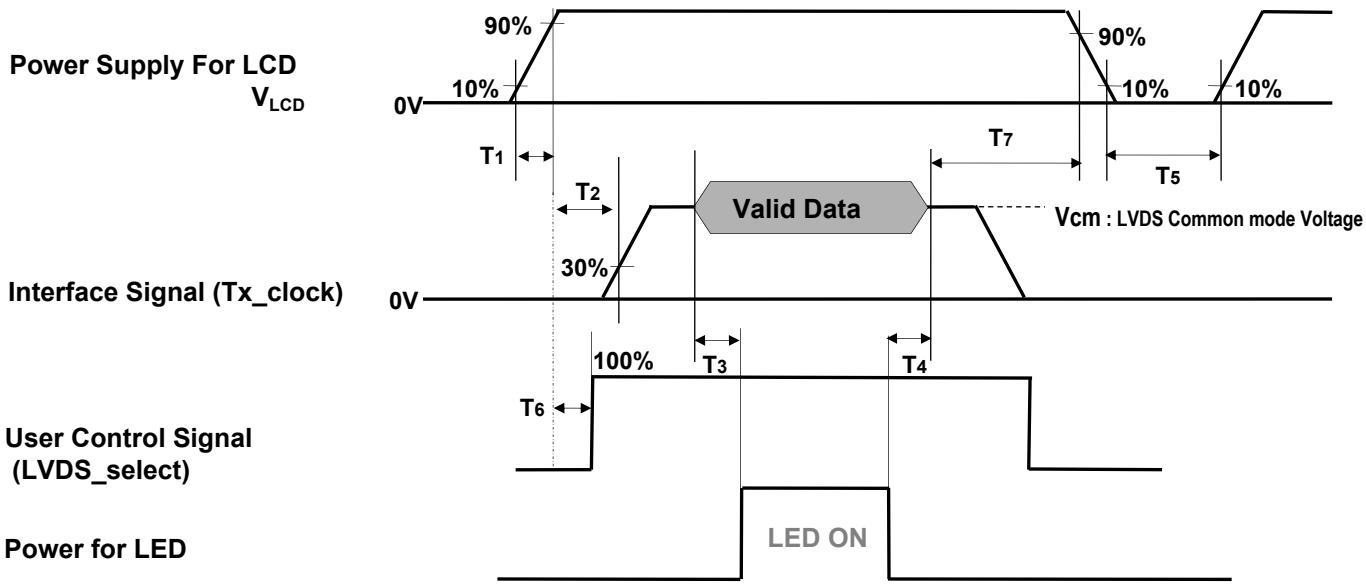


Table 7. POWER SEQUENCE

Parameter	Value			Unit	Note
	Min	Typ	Max		
T1	0.5	-	20	ms	1
T2	0	-	-	ms	2
T3	400	-	-	ms	3
T4	100	-	-	ms	3
T5	1.0	-	-	s	4
T6	0	-	T2	ms	5
T7	0	-	-	ms	6

Note :

1. Even though T1 is over the specified value, there is no problem if I2T spec of fuse is satisfied.
2. If T2 is satisfied with specification after removing LVDS Cable, there is no problem.
3. The T3 / T4 is recommended value, the case when failed to meet a minimum specification, abnormal display would be shown. There is no reliability problem.
4. T5 should be measured after the Module has been fully discharged between power off and on period.
5. If the on time of signals (Interface signal and user control signals) precedes the on time of Power (V_{LCD}), it will be happened abnormal display. When T6 is NC status, T6 doesn't need to be measured.
6. It is recommendation specification that T7 has to be 0ms as a minimum value.

※ Please avoid floating state of interface signal at invalid period.

※ When the power supply for LCD (VLCD) is off, be sure to pull down the valid and invalid data to 0V.

4. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable in a dark environment at 25±2°C. The values are specified at distance 50cm from the LCD surface at a viewing angle of Φ and θ equal to 0 °.
FIG. 1 shows additional information concerning the measurement equipment and method.

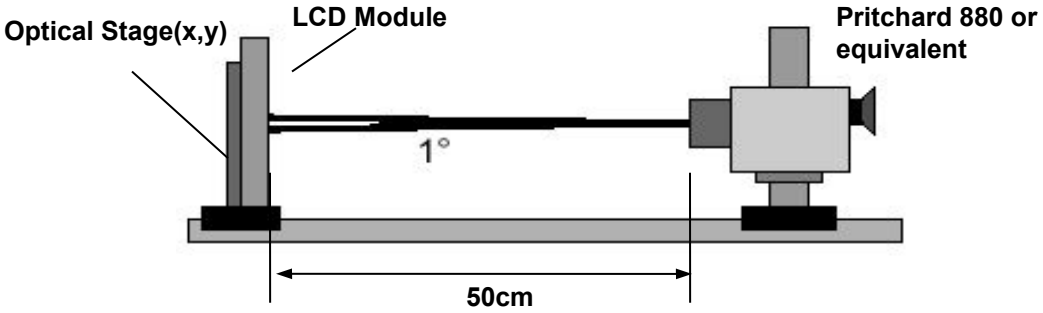


FIG. 1 Optical Characteristic Measurement Equipment and Method

Ta= 25±2°C, VDD,H_VDD,VGH,VGL=typ, fV=60Hz, Light Source : D65 Standard

Table 8. OPTICAL CHARACTERISTICS

Parameter		Symbol	Value			Unit	notes
			Min	Typ	Max		
Contrast Ratio		CR	800	1200	-		1
Response Time	Rising	Tr	-	8	12	ms	2
	Falling	Tf	-	10	14		
Transmittance		T	5.68	6.32		%	4
Color Coordinates [CIE1931]	RED	Rx	Typ -0.03	0.660	Typ +0.03		5
		Ry		0.327			
	GREEN	Gx		0.276			
		Gy		0.578			
	BLUE	Bx		0.135			
		By		0.113			
Viewing Angle (CR>10)							
	x axis, right(ϕ=0°)	θr	89	-	-	degree	6
	x axis, left (ϕ=180°)	θl	89	-	-		
	y axis, up (ϕ=90°)	θu	89	-	-		
	y axis, down (ϕ=270°)	θd	89	-	-		
Gray Scale			-	-	-		7

notes : 1. Contrast Ratio(CR) is defined mathematically as :

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

It is measured at center 1-point.

The contrast ratio is valued with operating condition of LGD's standard BLU

2. Response time is the time required for the display to transit from any gray to white (Rise Time, Tr_R) and from any gray to black (Decay time, Tr_D). For additional information see the FIG. 2.

※ G to G_{BW} Spec stands for average value of all measured points.

Photo Detector : RD-80S / Field : 2 °

The response time is valued with operating condition of LGD's standard BLU

3. G to G $_\sigma$ is Variation of Gray to Gray response time composing a picture

$$\text{G to G } (\sigma) = \sqrt{\frac{\Sigma(Xi - u)^2}{N}}$$

Xi = Individual Data
u = Data average
N : The number of Data

4. The value of transmittance should be extracted using the standard light source of D65

5. The value of color coordinates should be extracted using the standard light source of D65

6. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD module surface. For more information, see the FIG. 3.

7. Gray scale specification

Gamma Value is approximately 2.2. For more information, see the Table 9.

Table 9. GRAY SCALE SPECIFICATION

Gray Level	Luminance [%] (Typ)
L0	0.083
L15	0.28
L31	1.05
L47	2.50
L63	4.69
L79	7.67
L95	11.47
L111	16.11
L127	21.64
L143	28.07
L159	35.43
L175	43.73
L191	52.99
L207	63.23
L223	74.47
L239	86.72
L255	100

Response time is defined as the following figure and shall be measured by switching the input signal for "Black" ~ "White" and "White" ~ "Black".

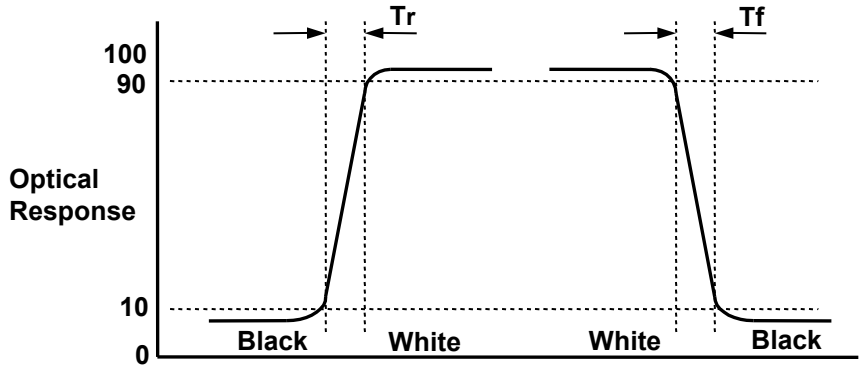


FIG. 2 Response Time

Dimension of viewing angle range

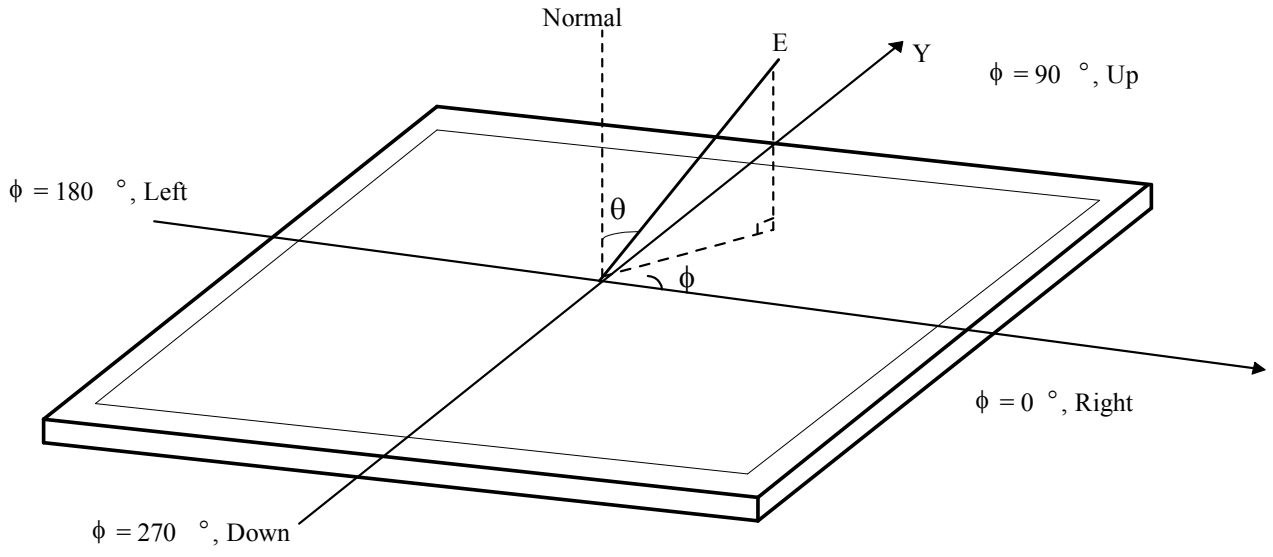


FIG. 3 Viewing Angle

5. Mechanical Characteristics

Table 10 provides general mechanical characteristics.

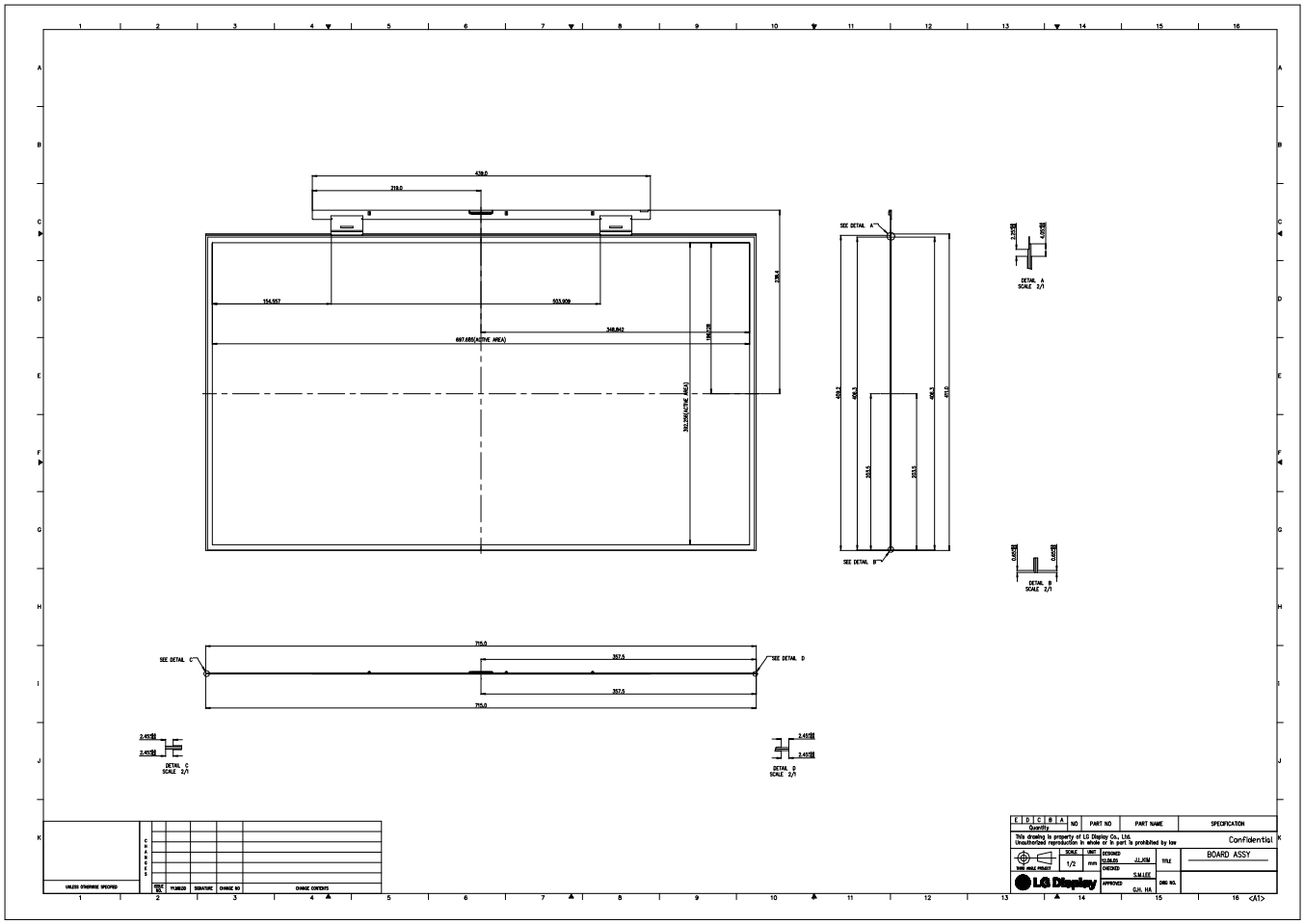
Table 10. MECHANICAL CHARACTERISTICS

Item	Value	
Outline Dimension (Only Glass)	Horizontal	715.0 mm
	Vertical	411.0 mm
	Thickness	1.4 mm
Active Display Area	Horizontal	697.9 mm
	Vertical	392.3 mm
Weight	0.86 kg(Typ.)	
Surface Treatment	Hard coating(3H), Anti-glare treatment of the front polarizer (Haze 1%(Typ.))	

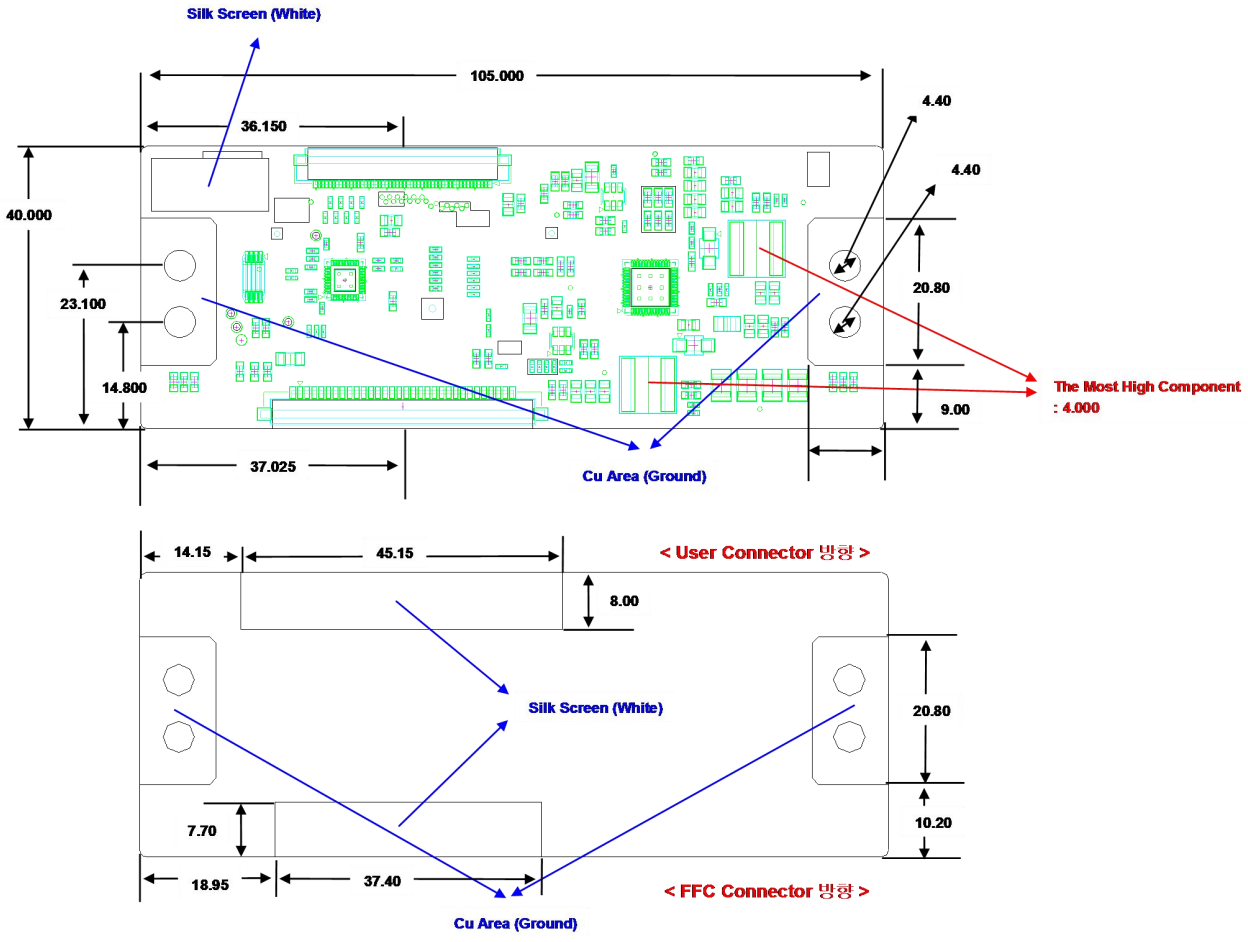
notes : Please refer to a mechanic drawing in terms of tolerance at the next page.

6. Mechanical Dimension

6-1. Board Assembly Dimension



6-2. Control Board Assembly Dimension



7. Reliability

Table 11. ENVIRONMENT TEST CONDITION

No.	Test Item	Condition
1	High temperature storage test	Ta= 60°C 90% 240h
2	Low temperature storage test	Ta= -20°C 240h
3	High temperature operation test	Ta= 50°C 50%RH 500h
4	Low temperature operation test	Ta= 0°C 500h
5	Humidity condition Operation	Ta= 40 °C ,90%RH
6	Altitude operating storage / shipment	0 - 16,400 ft 0 - 40,000 ft

notes : Before and after Reliability test, Board ass'y should be operated with normal function.

8. International Standards

8-1. Safety

a) UL 60065, Underwriters Laboratories Inc.
Audio, Video and Similar Electronic Apparatus - Safety Requirements.

b) CAN/CSA C22.2 No.60065:03, Canadian Standards Association.
Audio, Video and Similar Electronic Apparatus - Safety Requirements.

c) IEC 60065, The International Electrotechnical Commission (IEC).
Audio, Video and Similar Electronic Apparatus - Safety Requirements.

8-2. Environment

a) RoHS, Directive 2011/65/EU of the European Parliament and of the council of 8 June 2011

9. Packing

9-1. Packing Form

a) Package quantity in one Pallet : 306 pcs

b) Pallet Size : 1140 mm(L) X 910 mm(W) X 1218 mm(H)

10. Precautions

Please pay attention to the followings when you use this TFT LCD module.

10-1. Handling Precautions

(1) Please attach the surface transparent protective film to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.

(2) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit b reak by electro-chemical reaction.

(3) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth.(Some cosmetics are detrimental to the polarizer.)

(4) After removing the protective film, when the surface becomes dusty, please wipe gently with absorb ent cotton or other soft materials like chamois soaks with petroleum benzine. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.

(5) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.

(6) Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't tou ch interface pin directly. Panel ground path should be connected to metal ground.

(7) Please make sure to avoid external forces applied to the Source PCB and D-IC during the process of handling or assembling the TV set. If not, It causes panel damage or malfunction.

(8) Panel and BLU should be protected from the static electricity. If not, it causes IC damage.

(9) Do not pull or fold the source D-IC which connect the source PCB and the panel.

(10) Panel(board ass'y) should be put on the BLU structure precisely to avoid mechanical impact.

(11) FFC Cable should be connected between System board and Source PCB correctly.

(12) Mechanical structure for backlight system should be designed for sustaining board ass'y safely.

(13) Surface temperature of the Source D-IC should be controlled under 100℃ with TV Set status. If not, problems such as IC damage or decrease of lifetime could occur.

10-2. Operating Precautions

(1) Response time depends on the temperature.(In lower temperature, it becomes longer.)

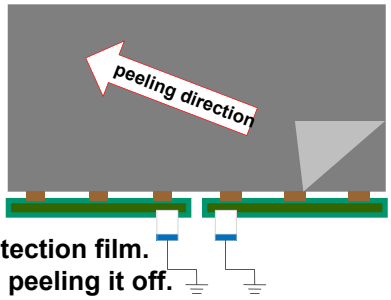
(2) Brightness depends on the temperature. (In lower temperature, it becomes lower.) And in lower temperature, Stable time(required time that brightness is stable after turned on) becomes longer

(3) Be careful for condensation at sudden temperature change. Condensation makes damage to polari zer or electrical contacted parts. And after fading condensation, smear or spot will occur.

(4) When fixed patterns are displayed for a long time, remnant image is likely to occur.

(5) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference sh all be done by system manufacturers. Grounding and shielding methods may be important to minimized the interference.

10-3. Protection Film



(1) Please keep attaching the protection film before assembly.
(2) Please peel off the protection film slowly.
(3) Please peel off the protection film just like shown in the Fig.4
(4) Ionized air should be blown over during the peeling.
(5) Source PCB should be connected to the ground when peel off the protection film.
(6) The protection film should not be contacted to the source D-IC during peeling it off.

< Fig. 4>

10-4. Storage Precautions

When storing modules as spares for a long time, the following precautions are necessary.

(1) Temperature : 5 ~ 40 ℃
(2) Humidity : 35 ~ 75 %RH
(3) Period : 6 months
(4) Control of ventilation and temperature is necessary.
(5) Please make sure to protect the product from strong light exposure, water or moisture. Be careful f or
condensation.
(6) Please keep the modules at a circumstance shown below Fig. 5

< Fig. 5 >

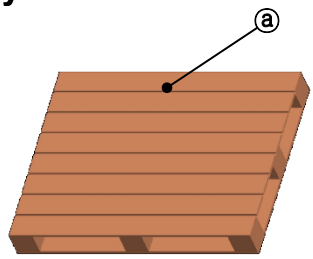
10-5. Packing Precautions

Product assembled into module should be stored in the Al-bag(cover case).

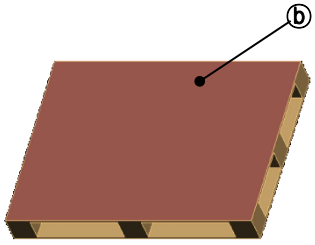
APPENDIX-I

■ Pallet Ass'y

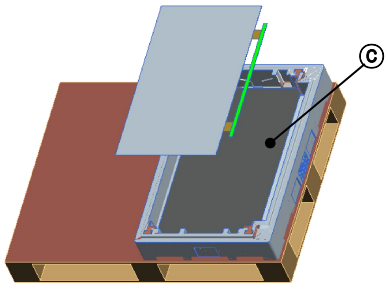
①



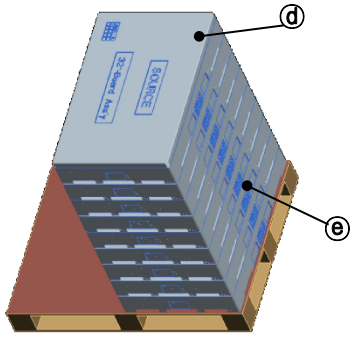
②



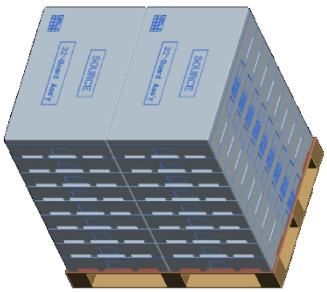
③



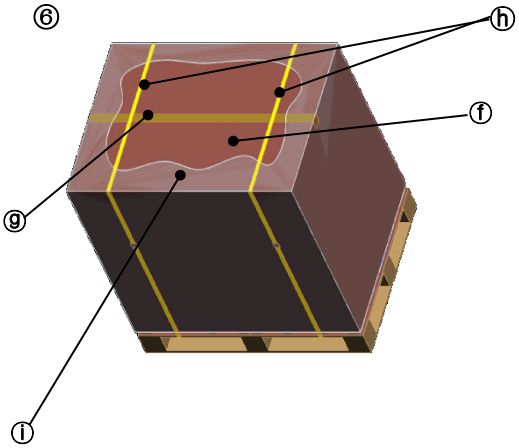
④



⑤



⑥



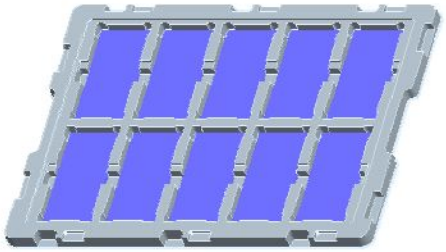
No.	Description	Material
ⓐ	Pallet	Plywood
ⓑ	Carton Plate	Single Wall
ⓒ	PE Sheet	LDPE
ⓓ	Top Packing	EPS
ⓔ	Bottom Packing	EPS
ⓕ	Angle Packing	Single Wall
ⓖ	Tape	OPP
ⓗ	Band	PP
ⓘ	Wrap	L-LDPE

APPENDIX-I-2

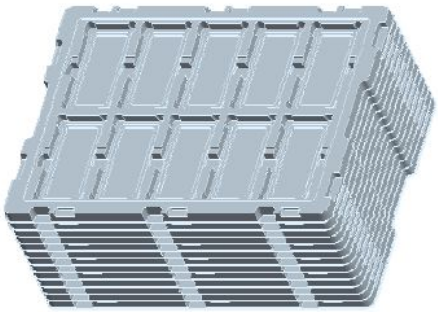
■ Control PCB Packing Ass'y

a) Control PCB Qty / Box : 160 pcs
b) Tray Qty / Box : 17Tray (Upperst Tray Is empty)
c) Tray Size : 466 X 353 X 16
d) Box size : 468 X 355X 197

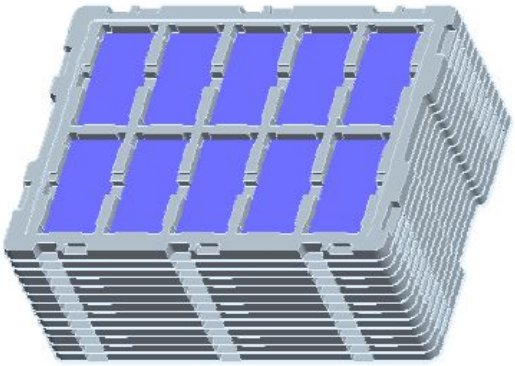
[10pcs/Tray]



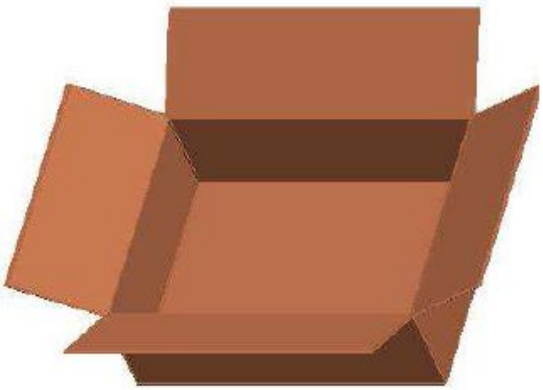
[17Tray+Empty Tray]



[16Tray]



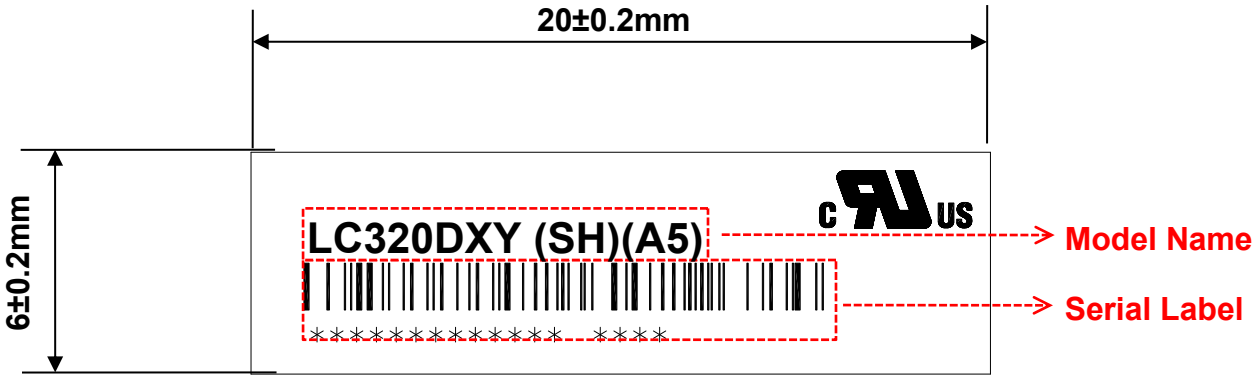
[Inserting into Box]



NO.	DESCRIPTION	MATERIAL
1	PCB Packing A,ssy	-
2	Tray	PET
3	Box	SWR4

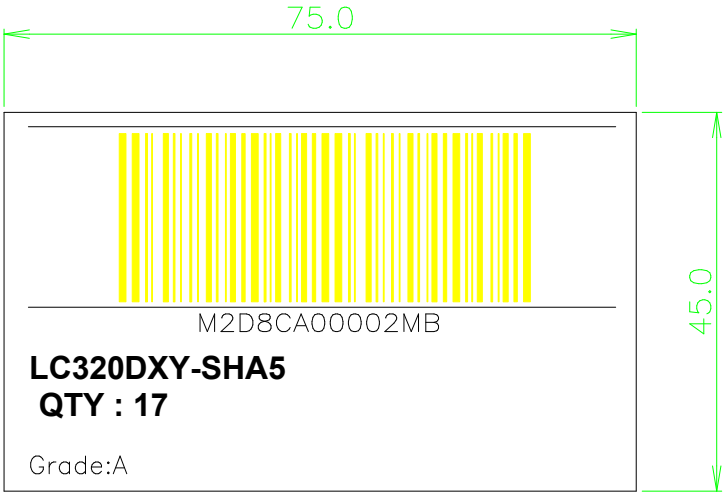
APPENDIX- II-1

■ Serial Label



APPENDIX- II-2

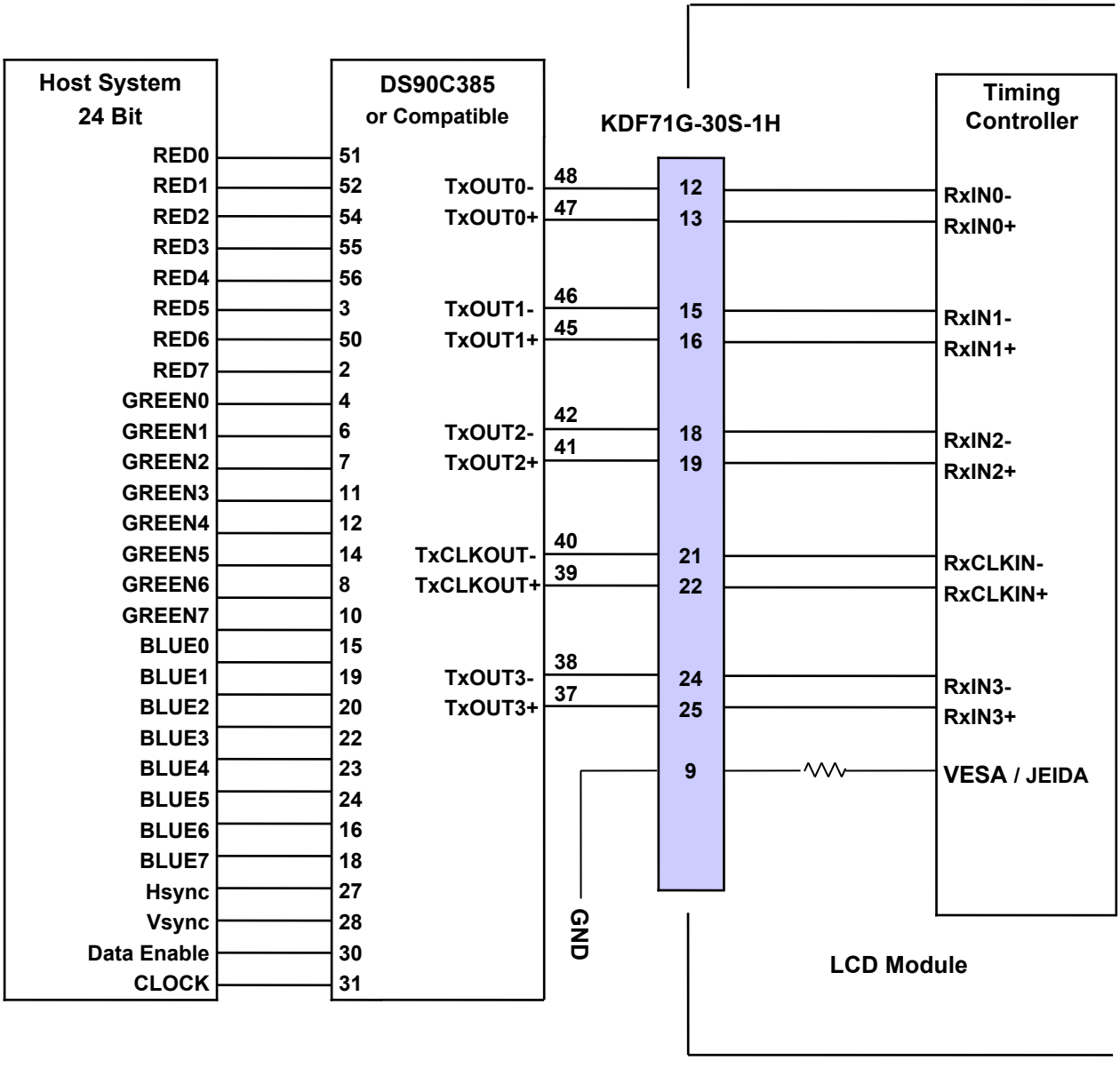
■ BOX Label



■ Pallet Label

APPENDIX- III-1

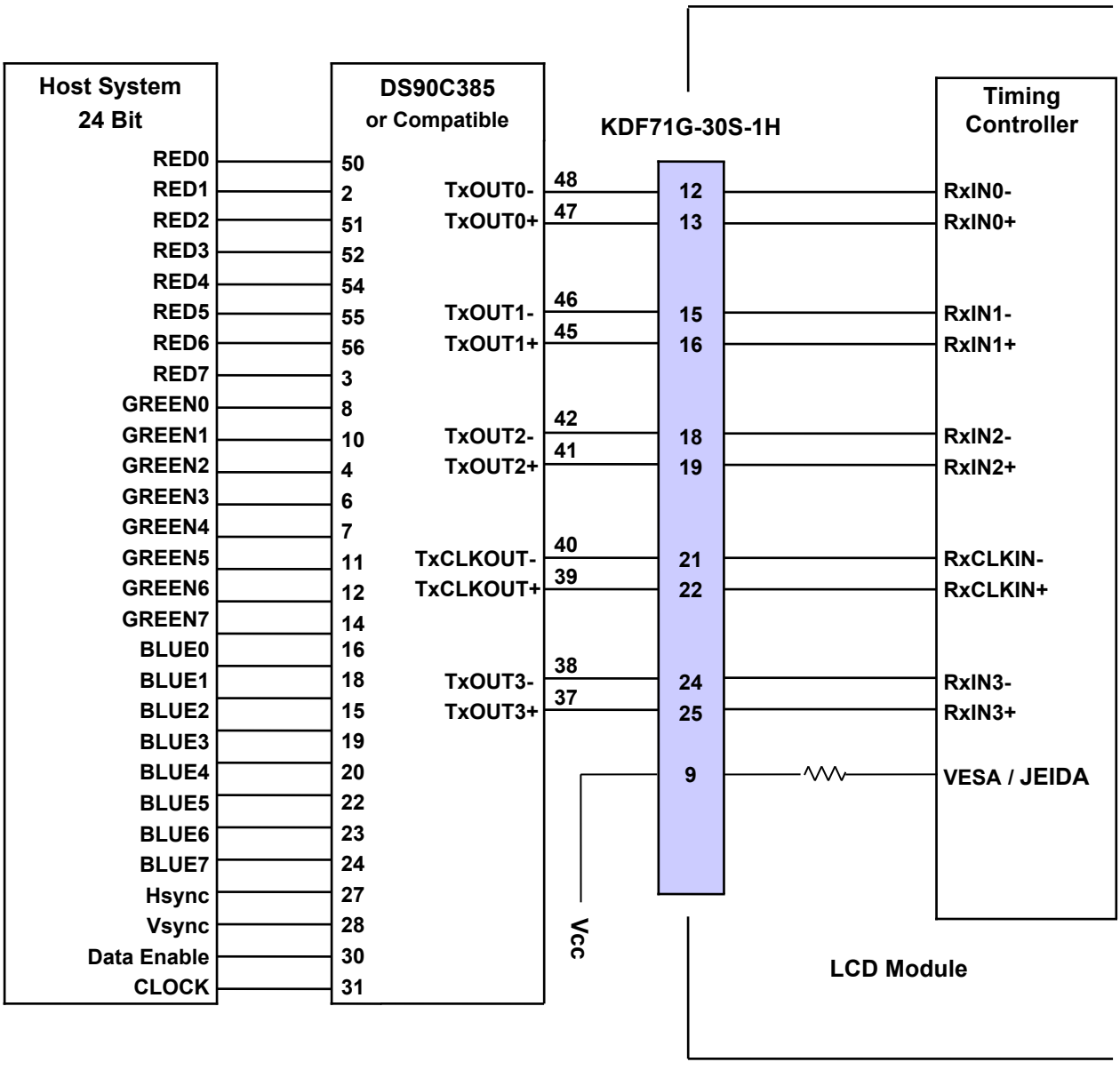
■ **Required signal assignment for Flat Link (Thine : THC63LVD103) Transmitter(Pin7= "L" or "NC")**



Note: 1. The LCD module uses a 100 Ohm[Ω] resistor between positive and negative lines of each rec eiver
input.
2. Refer to LVDS Transmitter Data Sheet for detail descriptions. (THC63LVD103 or Compatible)
3. '7' means MSB and '0' means LSB at R,G,B pixel data.

APPENDIX- III-2

■ **Required signal assignment for Flat Link (Thine : THC63LVD103) Transmitter(Pin7= "H")**



Note :1. The LCD module uses a 100 Ohm[Ω] resistor between positive and negative lines of each rece iver

input.

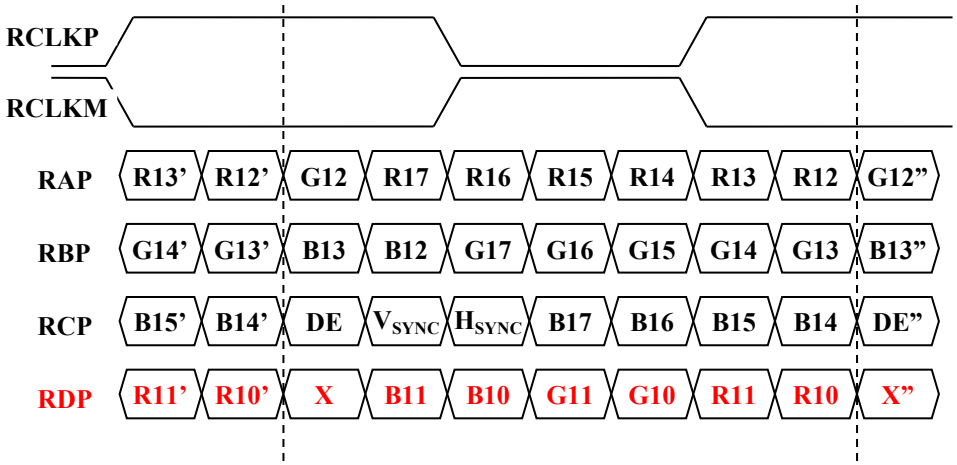
2. Refer to LVDS Transmitter Data Sheet for detail descriptions. (THC63LVD103 or Compatible)

3. '7' means MSB and '0' means LSB at R,G,B pixel data.

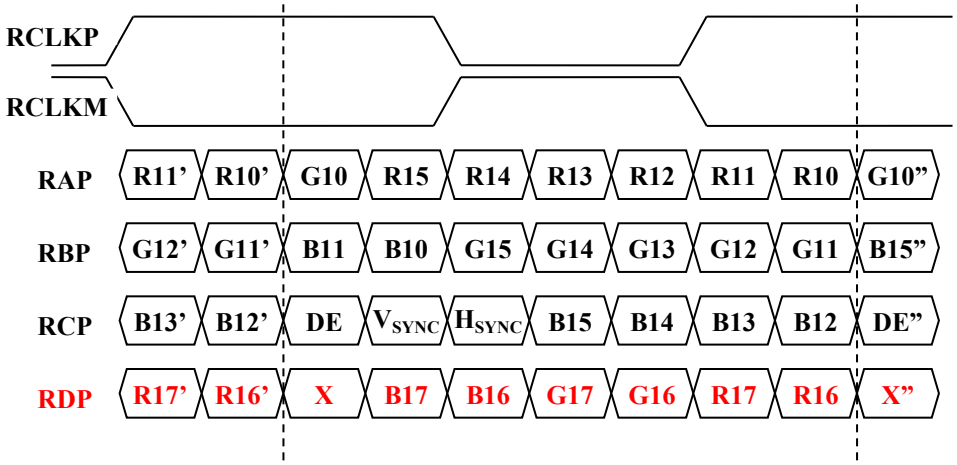
APPENDIX- IV

■ LVDS Data-Mapping Information (8 Bit)

1) LVDS Select : “H” Data-Mapping (JEIDA format)



2) LVDS Select : “L” Data-Mapping (VESA format)

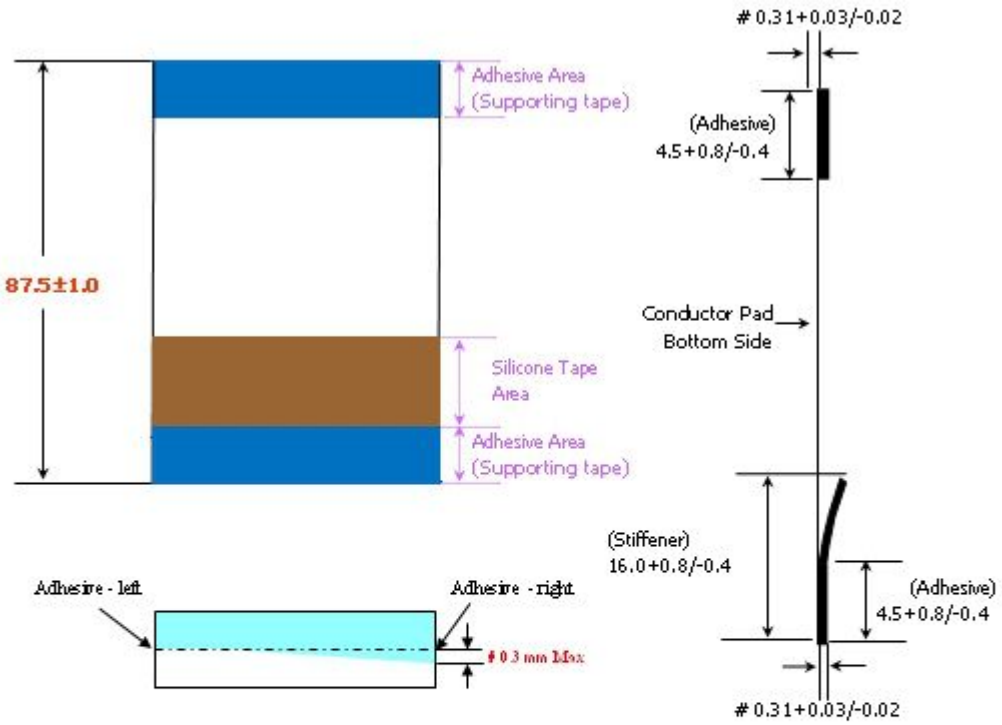


 # APPENDIX-V

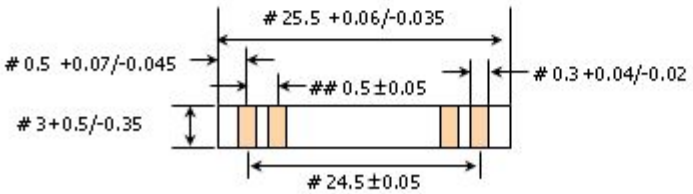
■ The reference method of BL dimming

It is recommended to use synchronous V-sync frequency to prevent waterfall (Vsync * 2 = P-Dim Frequency)

APPENDIX-VI



< Pad Detail– 50Pin >



◈ Note

- **Pad : GOLD Plating**
- **# ≥ Cpk 1.0**
- **## ≥ Cpk 1.33**
- **Stiffener color : Sky Blue**
- **H-F**
- **Dimensions unit : mm**

- Material List

APPLICATION	STANDARD	MATERIAL	REFERENCE
1. CONDUCTOR	GOLD PLATED COPPER WIRE	1. 99.99% COPPER 2. GOLD PLATED	1. Tolerance - THICKNESS: ±0.01 - WIDTH: +0.04 -0.02 2. ELOGATION(%) : 10 MORE THAN 3. TENSION : (KGF) 0.2 MORE THAN 4. GOLD THICKNESS : 0.05 μm MIN *MAKER : TAIHAN ELECTRIC plating process : J MICRON/SUNEUN
2. INSULATION	POLYESTER FILM (PET/PET)	1. POLYESTER BASE FILM : 0.025 mm 2. POLYESTER HOTMELT ADHESIVE : 0.035 mm TOTAL THICKNESS : 0.060 mm	UL VW-1 FLAME Width : 120mm Length : 500M UNIT : ROLL * MAKER : SHINCHANG HOTMELT/ COSMOAMT
3. SUPPORTING TAPE	POLYESTER FILM	1. POLYESTER BASE FILM : 0.188 mm 2. POLYESTER HOTMELT ADHESIVE : 0.027 mm TOTAL THICKNESS : 0.215 mm	Width : 20.5mm Length : 250M Unit : ROLL *MAKER : SUNGSHIN Trading/ COSMOAMT
4. SILICON TAPE (BROWN)		TOTAL THICKNESS : 0.065 mm	*MAKER : DAEHYUN ST